

NP45N06VDK

60 V - 45 A - N-channel Power MOS FET

R07DS1295EJ0200 Rev.2.00 May 24, 2018

Application: Automotive

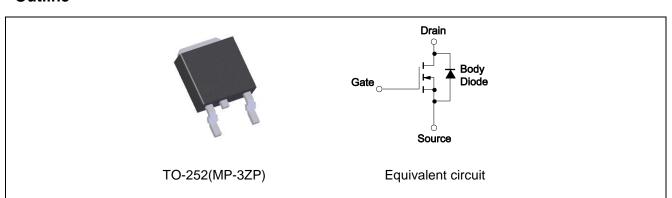
Description

NP45N06VDK is N-channel MOS Field Effect Transistor designed for high current switching applications.

Features

- Super low on-state resistance
 - $R_{DS(on)1}$ = 11.6 m Ω MAX. (V $_{GS}$ = 10 V, I_{D} = 23 A)
- Low C_{iss} : $C_{iss} = 1530 \text{ pF TYP.} (V_{DS} = 25 \text{ V})$
- Designed for automotive application and AEC-Q101 qualified

Outline



Remark: Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

Ordering Information

Part No.	Lead Plating	Packing		Package	
NP45N06VDK-E1-AY *1	Duro Cn (Tin)	Tape 2500 p/reel	Taping (E1 type)	TO-252(MP-3ZP)	
NP45N06VDK-E2-AY *1	Pure Sn (Tin)	rape 2500 p/reer	Taping (E2 type)	10-252(IVIF-52F)	

Note: *1. Pb-free (This product does not contain Pb in the external electrode)

Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V _{GS} = 0 V)	V _{DSS}	60	V
Gate to Source Voltage (V _{DS} = 0 V)	V _{GSS}	±20	V
Drain Current (DC) (T _C = 25°C)	I _{D(DC)}	±45	А
Drain Current (pulse) *1*3	I _{D(pulse)}	±135	А
Total Power Dissipation (T _C = 25°C)	P _{T1}	75	W
Total Power Dissipation (T _A = 25°C)	P _{T2}	1.2	W
Channel Temperature	T _{ch}	175	°C
Storage Temperature	T _{stg}	−55 to +175	°C
Repetitive Avalanche Current *2*3	I _{AR}	19	А
Repetitive Avalanche Energy *2*3	E _{AR}	36	mJ

Thermal Resistance

Channel to Case Thermal Resistance $R_{th(ch-C)}$ *3 2.00 °C/W Channel to Ambient Thermal Resistance $R_{th(ch-A)}$ *3 125 °C/W

Notes: *1. T_C = 25°C, PW \leq 10 μ s, Duty Cycle \leq 1%

*2. R_G = 25 $\Omega,~V_{GS}$ = 20 $V \rightarrow 0~V$

*3. Not subject of production test. Verified by design/characterization.

Electrical Characteristics (T_A = 25°C)

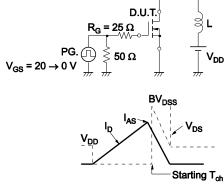
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Zero Gate Voltage Drain Current	I _{DSS}			1	μА	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$
Gate Leakage Current	I _{GSS}			±100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
Gate to Source Threshold Voltage	$V_{GS(th)}$	1.5	2.1	2.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Forward Transfer Admittance *1	y _{fs}	15	39		S	$V_{DS} = 5 \text{ V}, I_D = 23 \text{ A}$
Drain to Source On-state	R _{DS(on)1}		9.0	11.6	mΩ	$V_{GS} = 10 \text{ V}, I_D = 23 \text{ A}$
Resistance *1	R _{DS(on)2}		11.5	19.6	mΩ	$V_{GS} = 4.5 \text{ V}, I_D = 23 \text{ A}$
Input Capacitance *2	C _{iss}		1530	2300	pF	$V_{DS} = 25 V$,
Output Capacitance *2	Coss		155	240	pF	$V_{GS} = 0 V$,
Reverse Transfer Capacitance *2	C _{rss}		55	100	pF	f = 1 MHz
Turn-on Delay Time *2	t _{d(on)}		15	40	ns	$V_{DD} = 30 \text{ V}, I_D = 23 \text{ A},$
Rise Time *2	t _r		5	20	ns	$V_{GS} = 10 \text{ V},$
Turn-off Delay Time *2	$t_{d(off)}$		37	80	ns	$R_G = 0 \Omega$
Fall Time *2	t _f		3	10	ns	
Total Gate Charge *2	Q_{G}		25	38	nC	$V_{DD} = 48 \text{ V},$
Gate to Source Charge	Q _{GS}		6		nC	$V_{GS} = 10 \text{ V},$
Gate to Drain Charge	Q_{GD}		6		nC	I _D = 45 A
Body Diode Forward Voltage *1	V _{F(S-D)}		0.9	1.5	V	I _F = 45 A, V _{GS} = 0 V
Reverse Recovery Time	t _{rr}		28		ns	$I_F = 45 \text{ A}, V_{GS} = 0 \text{ V},$
Reverse Recovery Charge	Qrr		20		nC	di/dt = 100 A/μs

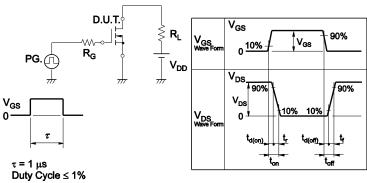
Note: *1. Pulsed test

Note: *2. Not subject of production test. Verified by design/characterization.

TEST CIRCUIT 1 AVALANCHE CAPABILITY

TEST CIRCUIT 2 SWITCHING TIME



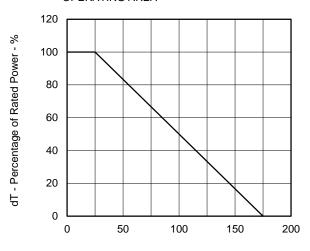


TEST CIRCUIT 3 GATE CHARGE

$$\begin{array}{c|c} \text{D.U.T.} & & \\ I_G = 2 \text{ mA} & & \\ \hline \\ PG. & > 50 \Omega & & \\ \hline \end{array} \quad \begin{array}{c} R_L \\ \hline \\ \end{array}$$

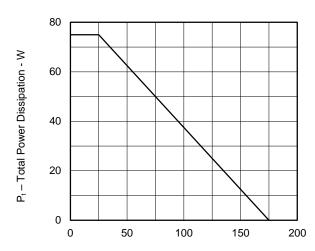
Typical Characteristics (T_A = 25°C)

DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



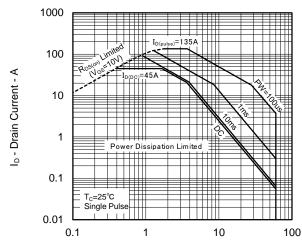
T_C - Case Temperature - °C

TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



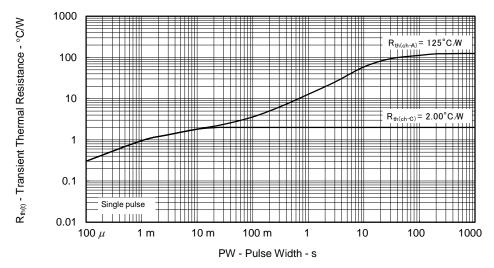
T_C - Case Temperature - °C

FORWARD BIAS SAFE OPERATING AREA

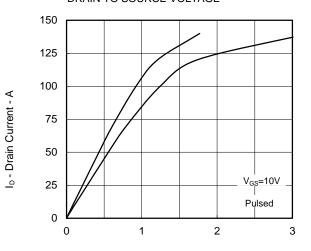


 V_{DS} - Drain to Source Voltage – V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

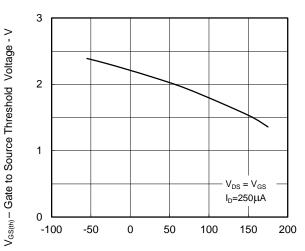


DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



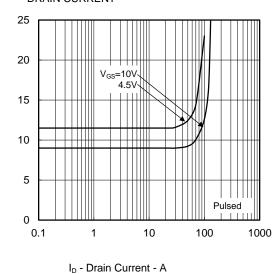
V_{DS} - Drain to Source Voltage - V

GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE

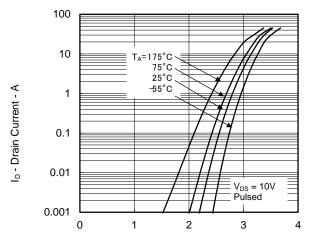


 T_{ch} - Channel Temperature - $^{\circ}C$

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

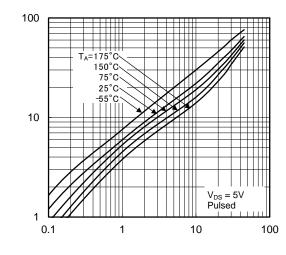


FORWARD TRANSFER CHARACTERISTICS



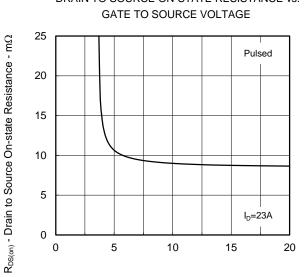
V_{GS} - Gate to Source Voltage - V

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs.

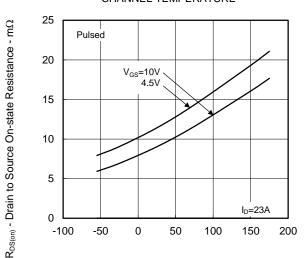
ID - Drain Current - A



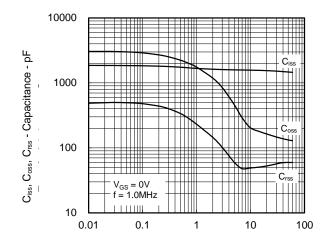
 V_{GS} - Gate to Source Voltage - V

 $R_{\text{DS(on)}}$ - Drain to Source On-state Resistance - $m\Omega$

| y_{fs} | - Forward Transfer Admittance - S

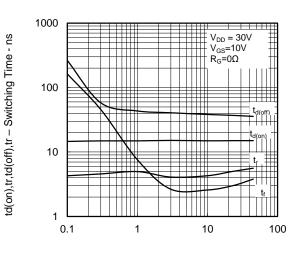


T_{ch} - Channel Temperature - °C



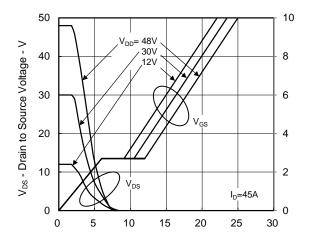
 V_{DS} - Drain to Source Voltage - V

SWITCHING CHARACTERISTICS



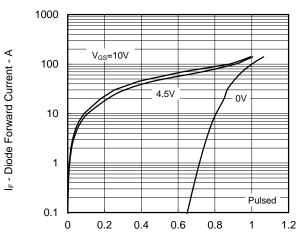
I_D - Drain Current - A

DYNAMIC INPUT CHARACTERISTICS



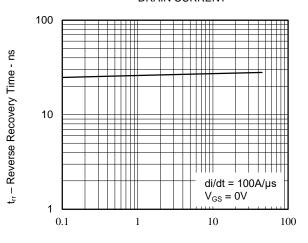
Q_G - Gate Charge - nC

SOURCE TO DRAIN DIODE FORWARD VOLTAGE



 $V_{F(S-D)}$ - Source to Drain Voltage - V

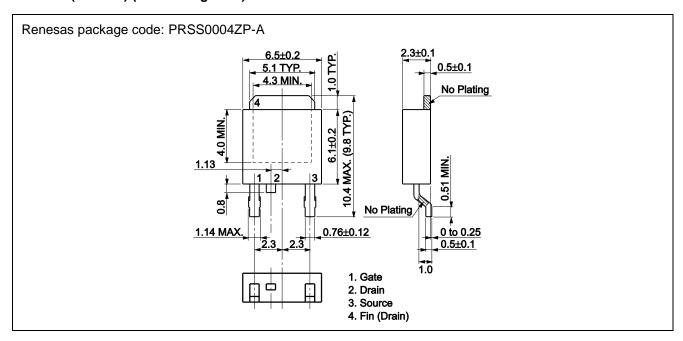
REVERSE RECOVERY TIME vs. DRAIN CURRENT



IF - Drain Current - A

Package Drawings (Unit: mm)

TO-252 (MP-3ZP) (Mass: 0.3 g TYP.)



Revision History

NP45N06VDK Data Sheet

		Description			
Rev.	Date	Page	Summary		
1.00	Oct. 26, 2015	_	First Edition Issued		
2.00	May 24 ,2018	2	Note 3 was added		
		3	Note 2 was added		

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